

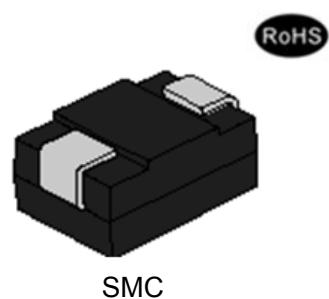


SM3K20CC Transient Voltage Suppressor

Rev.1.1

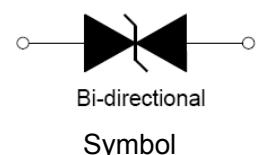
DESCRIPTION:

TVS diodes can be used in a wide range of applications which like consumer electronic products, automotive industries, munitions, telecommunications, aerospace industries, and intelligent control systems.



FEATURES:

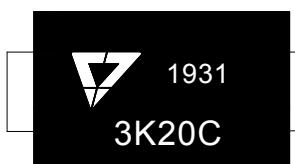
- ◊ Low profile package.
- ◊ Low inductance.
- ◊ Excellent clamping capability.
- ◊ 5000W peak pulse power capability at 10/1000μs waveform.
- ◊ High peak pulse voltage capability at 1.2/50μs-8/20μs@2Ω waveform.
- ◊ Fast response time: typically less than 1.0ps from 0V to V_{BR} min.
- ◊ High temperature to reflow soldering: 260 °C/40s at terminals.
- ◊ Plastic package has under writers laboratory flammability 94V-0.
- ◊ Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C.
- ◊ Terminal: solder plated, solderable per J-STD-002.
- ◊ For surface mounted applications in order to optimize board space.
- ◊ IEC61000-4-2 (ESD) ±30kV (air), ±30kV (contact).



ABSOLUTE MAXIMUM RATINGS (T_A=25 °C, RH=45%-75%, unless otherwise noted)

Parameter	Symbol	Value	Unit
Storage temperature range	T _{STG}	-55 to +150	°C
operating junction temperature range	T _J	-55 to +150	°C
Steady state power dissipation at T _L =75 °C	P _{M(AV)}	6.5	W
Peak pulse power dissipation at 10/1000μs waveform	P _{PP}	5000	W
Peak pulse voltage at 1.2/50μs-8/20μs@2Ω waveform	V _{PP}	6000	V
Peak pulse current at 1.2/50μs-8/20μs@2Ω waveform	I _{PP}	3000	A

MARKING



3K20C : Device Marking Code
1931: The 31th week, 2019

ELECTRICAL CHARACTERISTICS ($T_A=25^\circ\text{C}$)

Part Number	Marking Code	V_R	$I_R@V_R$	$V_{BR}@I_T$		I_T	$V_C@V_{PP}^{(1)}$	$V_{PP}^{(1)}$	$V_C@I_{PP}^{(2)}$	$I_{PP}^{(2)}$
Bi-Polar		V	max(µA)	min(V)	max(V)	mA	max(V)	V	max(V)	A
SM3K20CC	3K20C	20	5	22.2	24.5	1	40	6000	32.4	155.0

(1) Surge waveform: 1.2/50µs-8/20µs@2Ω

(2) Surge waveform: 10/1000µs

 V_R : Stand-off voltage -- Maximum voltage that can be applied V_{BR} : Breakdown voltage V_C : Clamping voltage -- Peak voltage measured across the suppressor at a specified V_{PP}/I_{PP} I_R : Reverse leakage current

ORDERING INFORMATION

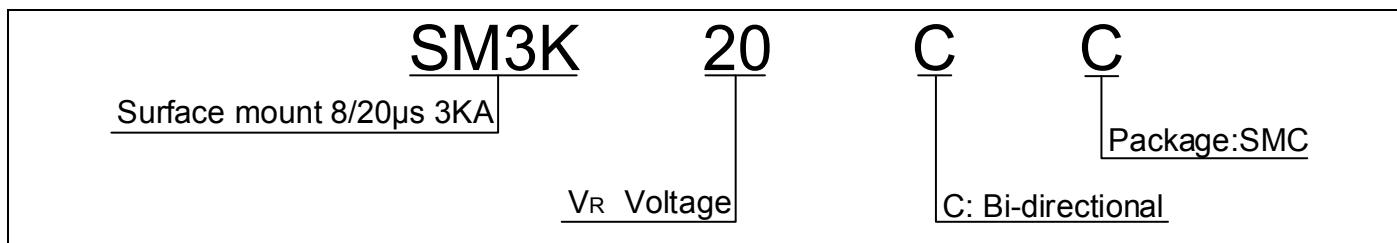
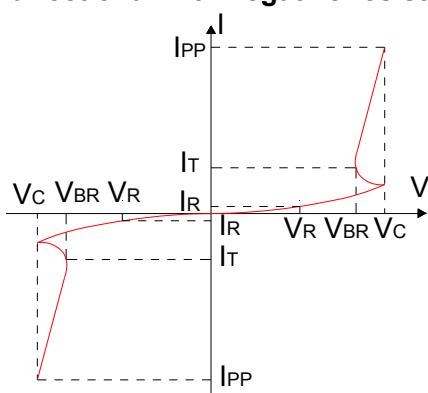
RATINGS AND V-I CHARACTERISTICS CURVES ($T_A=25^\circ\text{C}$, unless otherwise noted)FIG.1: V-I curve characteristics
(Bi-directional with negative resistance)

FIG.2: Pulse waveform

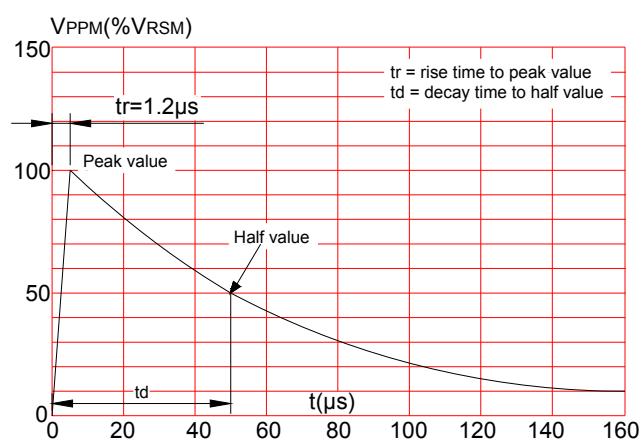


FIG.3: Pulse waveform

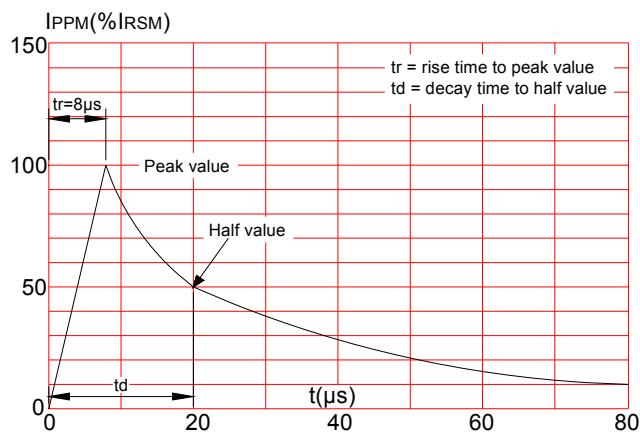


FIG.5: Pulse derating curve(10/1000μs)

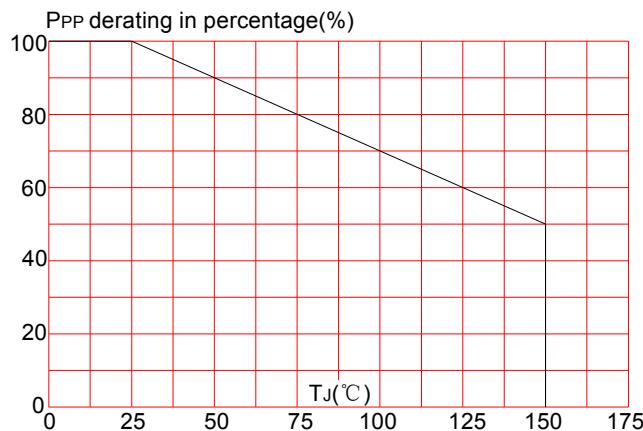


FIG.4: Pulse waveform

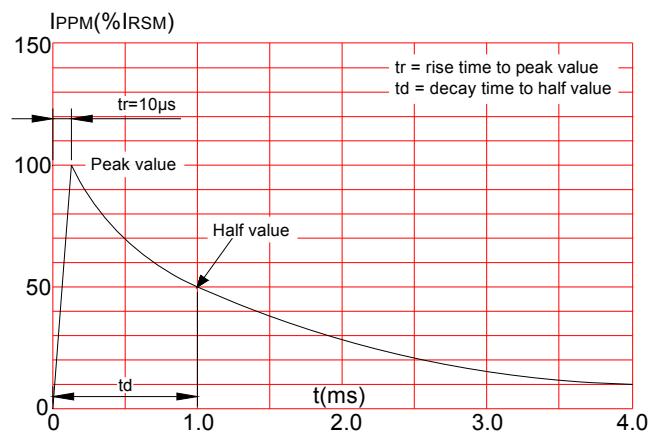
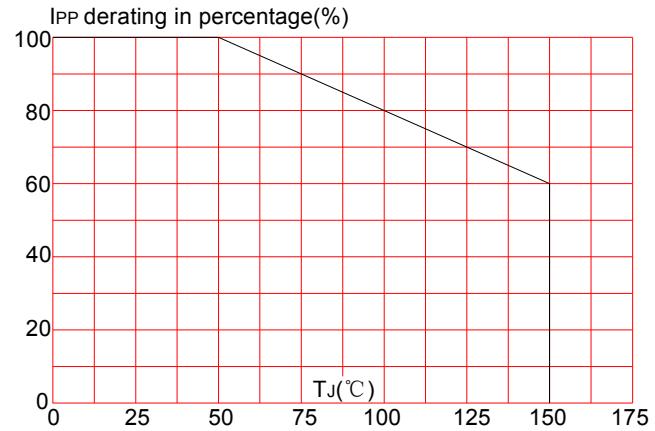
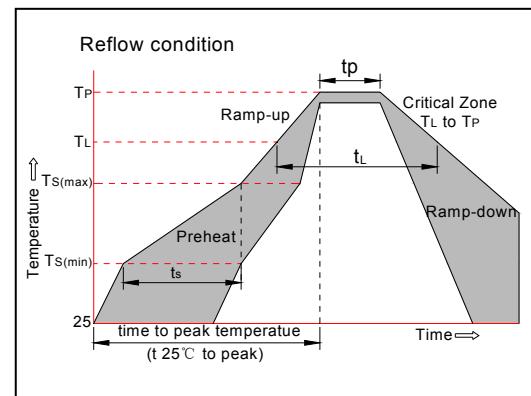


FIG.6: Pulse derating curve(8/20μs)

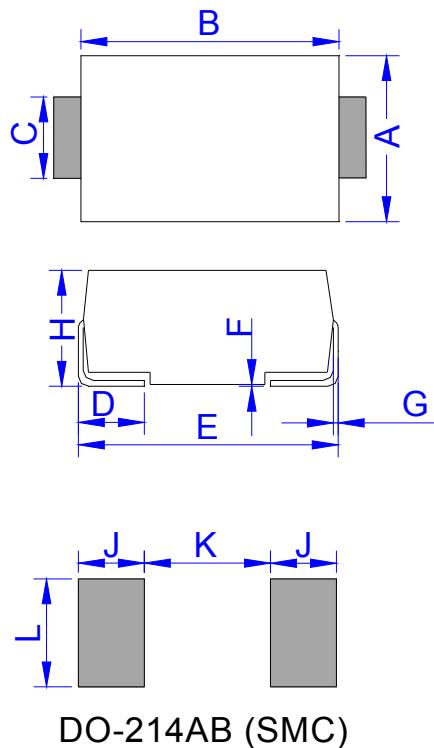


SOLDERING PARAMETERS

Reflow Condition		Pb-Free assembly (see figure at right)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150°C
	-Temperature Max($T_{s(max)}$)	+200°C
	-Time (Min to Max) (t_s)	60-180 secs.
Average ramp up rate (Liquidus Temp (T_L)to peak)		3°C/sec. Max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature(T_L)(Liquidus)	+217°C
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_p)		+260(+0/-5)°C
Time within 5°C of actual Peak Temp (t_p)		20-40secs.
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp (T_p)		8 min. Max
Do not exceed		+260°C

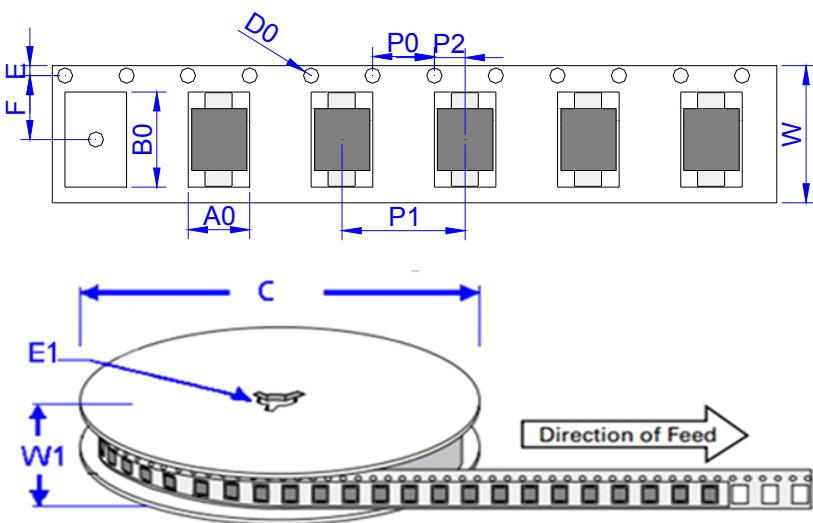


PACKAGE MECHANICAL DATA



Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	5.75	6.25	0.226	0.246
B	6.90	7.40	0.272	0.291
C	2.75	3.25	0.108	0.128
D	0.95	1.52	0.037	0.060
E	7.70	8.20	0.303	0.323
F	0.051	0.203	0.002	0.008
G	0.15	0.31	0.006	0.012
H	2.15	2.62	0.085	0.103
J	2.40		0.094	
K		4.20		0.165
L	3.30		0.130	

TAPE AND REEL SPECIFICATION-SMC



Ref.	Dimensions	
	Millimeters	Inches
A0	6.05 ± 0.3	0.238 ± 0.012
B0	8.31 ± 0.3	0.327 ± 0.012
C	330.0	13.0
D0	1.55 ± 0.1	0.061 ± 0.004
E	1.75 ± 0.2	0.069 ± 0.008
E1	13.3 ± 0.3	0.524 ± 0.012
F	7.50 ± 0.2	0.295 ± 0.008
P0	4.00 ± 0.2	0.157 ± 0.008
P1	8.00 ± 0.2	0.3145 ± 0.008
P2	2.00 ± 0.2	0.079 ± 0.008
W	16.0 ± 0.2	0.630 ± 0.008
W1	19.7 ± 2.0	0.776 ± 0.079

PART No.	UNIT WEIGHT (g/PCS) typ.	REEL (PCS)	PER CARTON (PCS)	DESCRIPTION
SM3K20CC	0.294	3,000	48,000	13 inch reel pack

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